MP20049
Ultra-Low Noise, High PSRR
150mA Linear Regulator in 0.8x0.8mm WLCSP

The Future of Analog IC Technology®

DESCRIPTION

The MP20049 is an ultra-low noise, low-dropout, high PSRR linear regulator. Fixed output voltage options are available between 1.2V to 4.5V with 1% accuracy while operating from a +2.3V to +6V input. It is designed to deliver up to 150mA of load current. Dropout voltage is only 60mV at full load.

The MP20049 uses an internal PMOS as the pass element, which consumes 50µA supply current at no load condition and is suitable for battery-power devices. New innovative design techniques enable the MP20049 to achieve ultra-low output voltage noise of only $16\mu V_{RMS}$ without a noise bypass capacitor.

The MP20049 is designed and optimized to work with low value, low cost ceramic capacitors. It typically requires only 1µF of output capacitance for stability with any load.

The MP20049 features current limit and over temperature protection and is available in a tiny 4-ball 0.8x0.8mm WLCSP package.

FEATURES

- Linear Regulator in 0.8x0.8mm WLCSP
- Input Voltage Range: 2.3V to 6V
- Up to 150mA Output Current
- $16\mu V_{RMS}$ Output Noise (100Hz to 100kHz) with No Bypass Capacitor required
- High PSRR:
  - 78dB @1kHz
  - 55dB @100kHz
- Low Dropout:
  - 50mV @120mA Load
  - 60mV @150mA Load
- Stable with 1µF Ceramic Capacitor for Any Load
- Very Fast Line/Load Transient Response
- Current Limit and Thermal Protection

APPLICATIONS

- Cellular Mobile Phones
- Digital Cameras
- Handheld and Battery-powered Equipment
- Wireless LAN
- Post DC-to-DC Regulation

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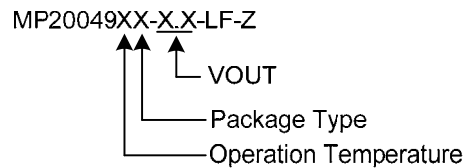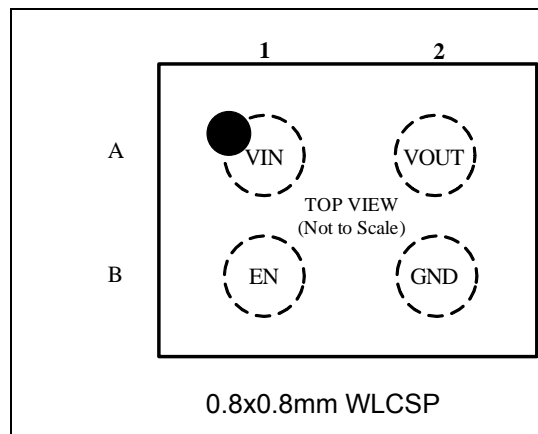
TYPICAL APPLICATION
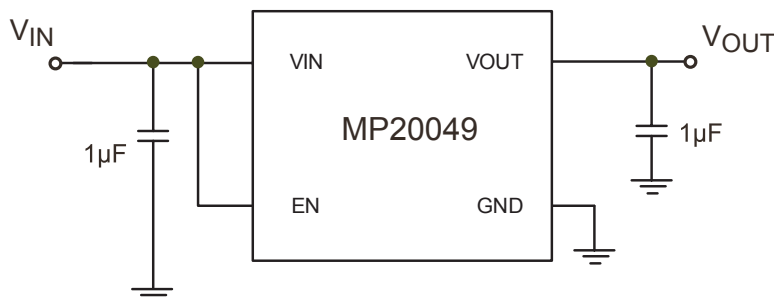
ORDERING INFORMATION

Part Number*	Package	VOUT(V)	Top Marking	Free Air Temperature (T$_A$)
MP20049DC-2.8**	WLCSP (0.8x0.8mm)	2.8	TCO	-40°C to +125°C

* For Tape & Reel, add suffix –Z (e.g. MP20049DC–Z);
For RoHS, compliant packaging, add suffix –LF (e.g. MP20049DC–LF–Z).
** Contact factory for other fixed Output Options.

ORDERING GUIDE**

MP20049XX-X.X-LF-Z

└─ VOUT
└─ Package Type
└─ Operation Temperature

PACKAGE REFERENCE

TOP VIEW
(Not to Scale)

0.8x0.8mm WLCSP

ABSOLUTE MAXIMUM RATINGS [1]

Supply Input Voltage 6.5V
Continuous Power Dissipation (T$_A$ = +25°C) [2]
WLCSP 0.37W
Storage Temperature Range .... -65°C to 150°C
Lead Temperature (Soldering, 10sec) ....300°C

ESD SUSCEPTIBILITY [3]

HBM (Human Body Mode) 2kV
MM (Machine Mode) 200V

Recommended Operating Conditions [4]

Supply Input Voltage ....2.3V to 6.0V
Enable Input Voltage ....0V to 5.5V
Operating Junct. Temp (T$_J$)...... -40°C to +125°C

Thermal Resistance [5]   θ$_{JA}$ θ$_{JC}$

WLCSP.................................330 ..... n/a .. °C/W

Notes:
1) Exceeding these ratings may damage the device.
2) The maximum allowable power dissipation is a function of the maximum junction temperature T$_J$ (MAX), the junction-to-ambient thermal resistance θ$_{JA}$, and the ambient temperature T$_A$. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P$_D$ (MAX) = (T$_J$ (MAX)-T$_A$)/θ$_{JA}$. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
3) Devices are ESD sensitive. Handling precaution recommended.
4) The device is not guaranteed to function outside of its operating conditions.
5) Measured on JESD51-7, 4-layer PCB.

ELECTRICAL CHARACTERISTICS

V_{IN} = (V_{OUT} + 0.5V) or 2.5 V (whichever is greater), EN = V_{IN}, I_{OUT} = 10mA, C_{IN} = C_{OUT} = 1µF
T_A = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input voltage range	V_{IN}		2.3		6	V
Maximum Output Current	I_{MAX}	Continuous	150			mA
Output Voltage Accuracy	ΔV_{OUT}	I_{OUT} = 10mA	-1		+1	%
Current Limit	I_{LIM}	R_{Load}=1Ω	165	250	380	mA
Ground Current	I_Q	No Load(25°C)	40	55	70	µA
		No Load(-40°C<T_A<85°C)	40		75	µA
Dropout Voltage [6]	V_{DROP}	V_{OUT} = 2.8V, I_{OUT} = 80mA T_J=-40°C to 125°C		40	110	mV
		V_{OUT} = 2.8V, I_{OUT} = 120mA T_J=-40°C to 125°C		50	120	mV
Line regulation[7]	V_{LNR}	V_{IN}=3.3v to 6v I_{OUT}=0.1mA	-0.06		+0.06	%/V
Load regulation[8]	V_{LDR}	I_{OUT}=1mA to150mA		0.001		%/mA
EN Input High Threshold	V_{IH}	V_{IN} = 3.3V to 5.5V	1.2			V
EN Input Low Threshold	V_{IL}	V_{IN} = 3.3V to 5.5V			0.4	V
EN Input Bias Current	I_{SD}	EN = V_{IN}= 5.5V		100	300	nA
Shutdown Supply Current	I_{GSD}	EN = GND		0.03	1	µA
Thermal Shutdown Temperature	T_{SD}			150		°C
Thermal Shutdown Hysteresis	ΔT_{SD}			20		°C
Output Voltage Noise		10Hz to 100kHz, C_{OUT}=4.7µF, Vout=1.2V I_{LOAD}=10mA		16		µV_{RMS}
Output Voltage AC PSRR		1kHz, C_{OUT} = 2.2µF, I_{LOAD} = 10mA		78		dB
		10kHz , C_{OUT} = 2.2µF, I_{LOAD} = 10mA		75		dB
		100kHz , C_{OUT} = 2.2µF, I_{LOAD} = 10mA		55		dB

Notes:

6) Dropout Voltage is defined as the input to output differential when the output voltage drops 100mV below its nominal value.

7) Line Regulation= $\dfrac{\left| V_{OUT[V_{IN(MAX)}]} - V_{OUT[V_{IN(MIN)}]} \right|}{\left[V_{IN(MAX)} - V_{IN(MIN)} \right] \times V_{OUT(NOM)}} \times (\% / V)$
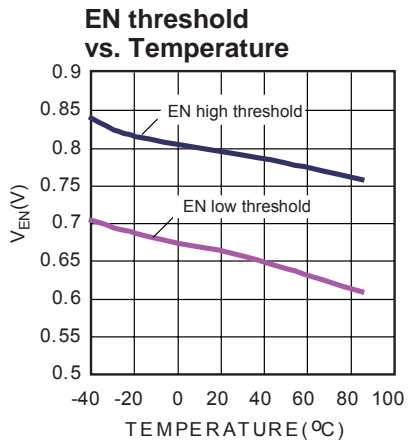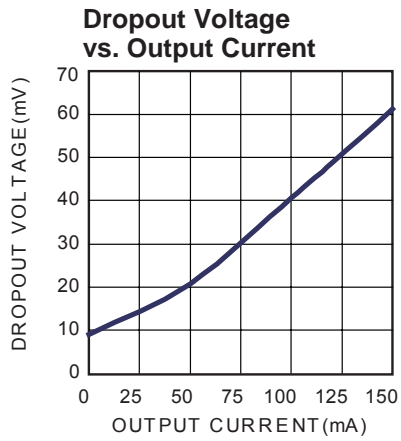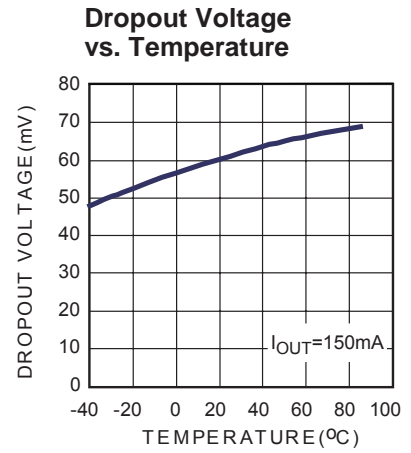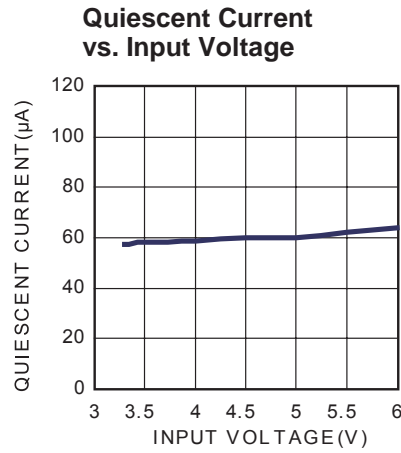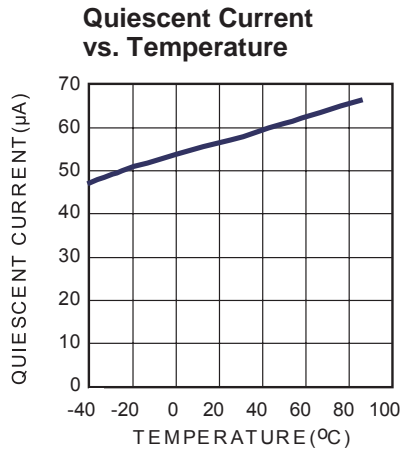
8) Load Regulation= $\dfrac{V_{OUT[I_{OUT(MAX)}]} - V_{OUT[I_{OUT(MIN)}]}}{[I_{OUT(MAX)} - I_{OUT(MIN)}] * V_{OUT(NOM)}}$

PIN FUNCTIONS

| Pin#	Name	Description
A1	VIN	Regulator Input Supply. Bypass VIN to GND with a 1µF or greater capacitor.
B2	GND	Ground Pin.
B1	EN	Enable Input. Drive EN high to turn on the Regulator; drive it low to turn off the Regulator. For automatic startup, connect EN to VIN.
A2	VOUT	Regulated Output Voltage. Connect a 1µF or greater output capacitor between VOUT and GND.

TYPICAL PERFORMANCE CHARACTERISTICS
V_{IN}=3.3V, V_{OUT}=2.8V, C_{IN}=C_{OUT}=1µF, T_A=25°C, unless otherwise noted
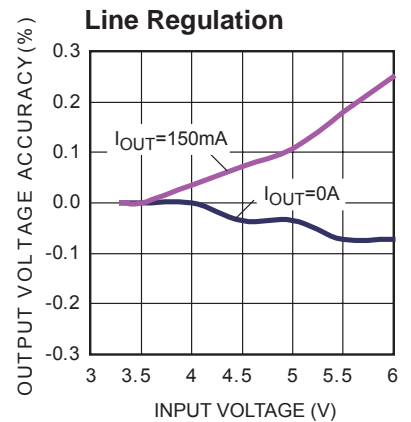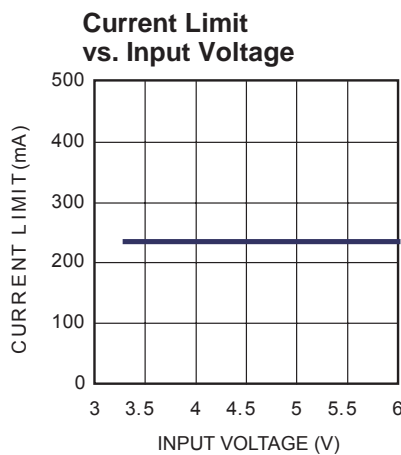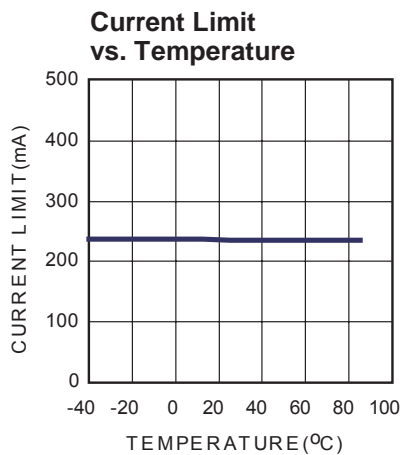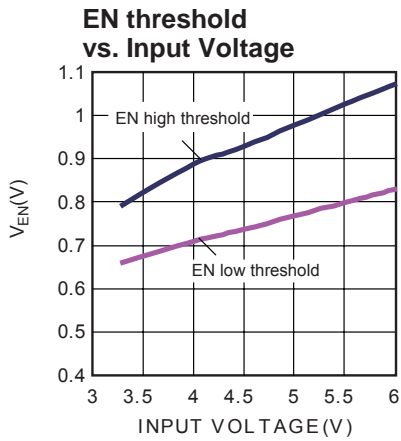
### Quiescent Current vs. Temperature

Quiescent Current vs. Input Voltage

Dropout Voltage vs. Temperature

Dropout Voltage vs. Output Current

EN threshold vs. Input Voltage

EN threshold vs. Temperature

Current Limit vs. Temperature

Current Limit vs. Input Voltage

Line Regulation

TYPICAL PERFORMANCE CHARACTERISTICS (*continued*)

V_{IN}=3.3V, V_{OUT}=2.8V, C_{IN}=C_{OUT}=1µF, T_A=25°C, unless otherwise noted

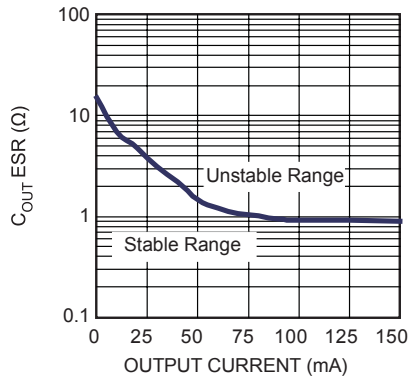### Load Regulation
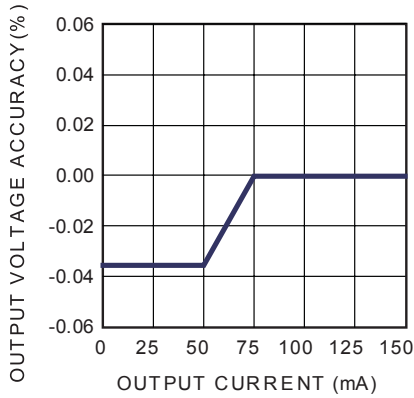
Output Voltage Accuracy vs. Temperature
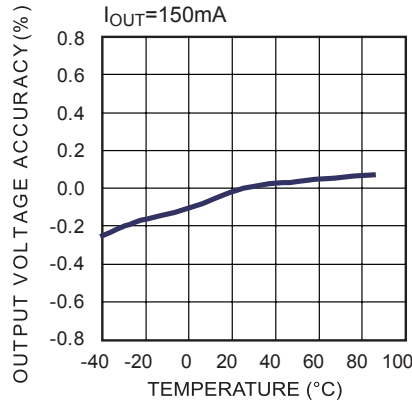
I_{OUT}=150mA

PSRR

I_{OUT}=10mA, 50mA, 100mA, 150mA
f ranges from 10Hz to 10MHz
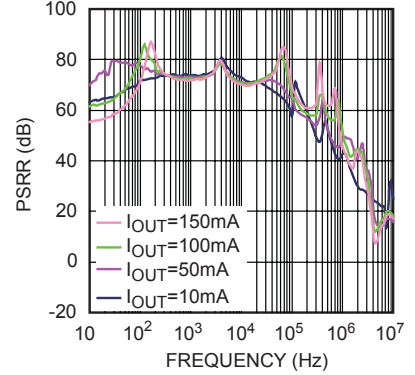
Region of Stable C_{OUT} ESR vs. Output Current

TYPICAL PERFORMANCE CHARACTERISTICS (*continued*)
V_{IN}=3.3V, V_{OUT}=2.8V, C_{IN}=C_{OUT}=1µF, T_A=25°C, unless otherwise noted

Input Power Start Up
I_{OUT}=150mA, with Resistor Load
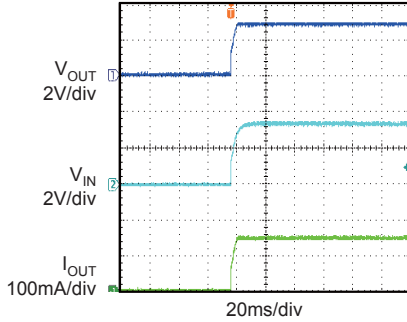
Input Power Shutdown
I_{OUT}=150mA, with Resistor Load
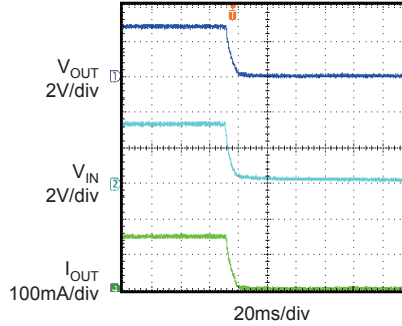
EN Start Up
I_{OUT}=150mA, with Resistor Load
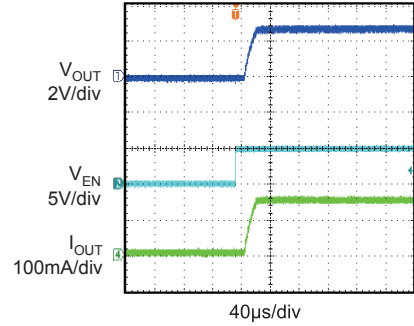
EN Shutdown
I_{OUT}=150mA, with Resistor Load
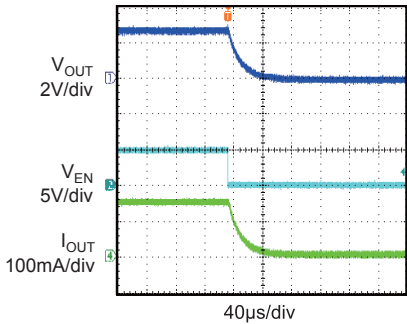
Line Transient
V_{IN}=2.5V to 5V, I_{OUT}=60mA,
with Resistor Load
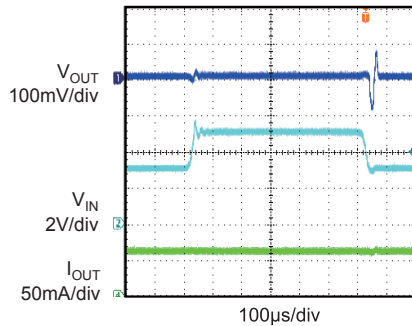
Load Transient
I_{OUT}=1mA to 65mA,
with Resistor Load
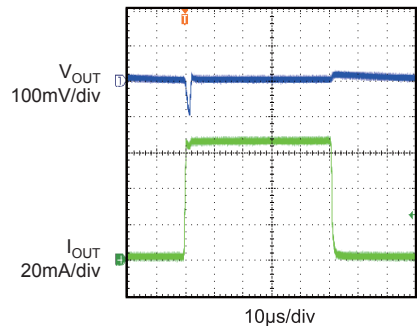
Over Current Protection Entry
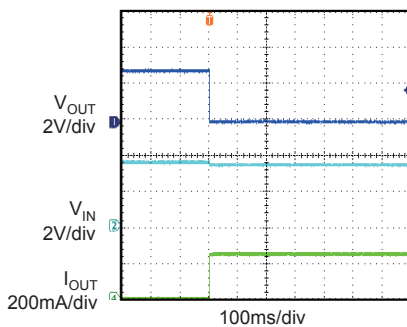
Over Current Protection Steady State
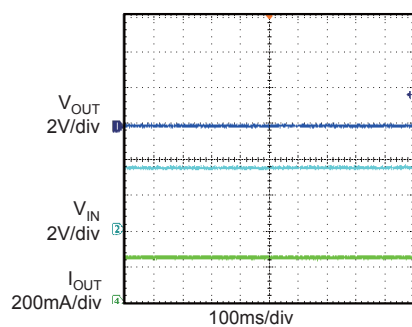
Over Current Protection Recovery
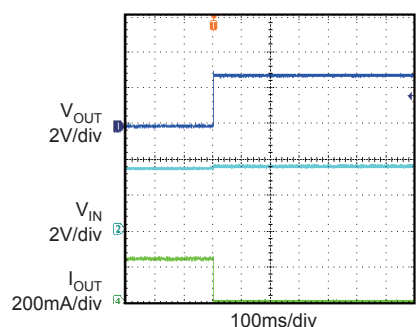
OPERATION

The MP20049 is an ultra low noise, low dropout, low quiescent current and high PSRR linear regulator for space-restricted applications. It is intended for use in devices that require very low voltage, and ultra-small footprint, such as mobile phone and MP3 players.

The MP20049 uses an internal PMOS as the pass elements and features internal thermal shutdown and internal current limit circuits.

Dropout Voltage

Dropout voltage is the minimum input to output differential voltage required for the regulator to maintain an output voltage within 100mV of its nominal value. It determines the available end-of-life battery voltage in battery-powered systems. For the P-channel MOSFET pass element, the dropout voltage is a function of drain to source on resistance. Because the P-channel MOSFET pass element behaves as a low-value resistor, the dropout voltage of MP20049 is very low.

Under Voltage Lockout

The MP20049 has an internal under-voltage lockout circuit that disables the device when the input voltage is less than approximately 2.3V. This ensures that the input and the output of the

MP20049 behave in a predictable manner during input power-up.

Enable ON/Off

The MP20049 can be switched ON or OFF by a logic input at the EN pin. A high voltage at this pin will turn the device on. When the EN pin is low, the regulator output is off. The EN pin should be tied to VIN to keep the regulator output always on if the application does not require the shutdown feature.
Do not float the EN pin.

Current Limit and Thermal Protection

The MP20049 includes an independent current limit structure which monitors and controls the P-channel MOSFET's gate voltage to limit the guaranteed maximum output current to 150mA.

Thermal protection turns off the P-channel MOSFET when the junction temperature exceeds +150ºC, allowing the IC to cool. When the IC's junction temperature drops by 20ºC, the PMOS will be turned on again. Thermal protection limits total power dissipation in the MP20049. For reliable operation, junction temperature should be limited to 125ºC maximum.
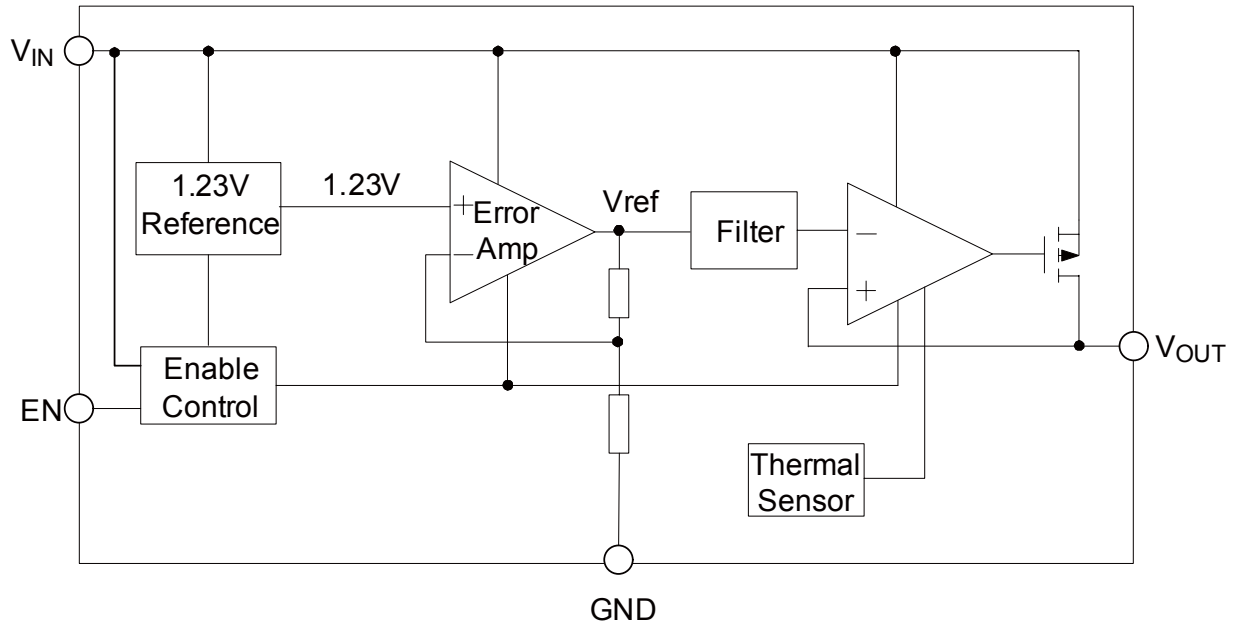
FUNCTIONAL BLOCK DIAGRAM

Figure 1—Functional Block Diagram

APPLICATION INFORMATION

Power Dissipation

The power dissipation for any package depends on the thermal resistance of the case and circuit board, the temperature difference between the junction and ambient air, and the rate of airflow. The power dissipation across the device can be represented by the equation:

$$P = (V_{IN} - V_{OUT}) \times I_{OUT}$$

The allowable power dissipation can be calculated using the following equation:

$$P_{(MAX)} = (T_{Junction} - T_{Ambient}) / \theta_{JA}$$

Where ($T_{Junction}$ - $T_{Ambient}$) is the temperature difference between the junction and the surrounding environment, θ_{JA} is the thermal resistance from the junction to the ambient environment. Connecting the GND pin of MP20049 to ground with a large ground plane will help the channel heat away.

Input Capacitor Selection

Using a capacitor whose value is >1µF on the MP20049 input and the amount of capacitance can be increased without limit. Larger values will help to improve line transient response with the drawback of increased size. Ceramic capacitors are preferred, but tantalum capacitors may also suffice.
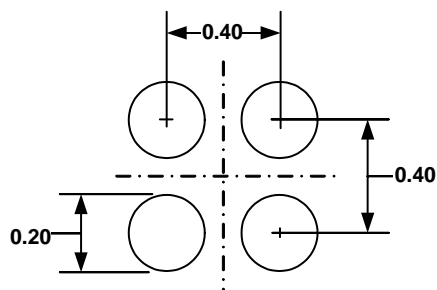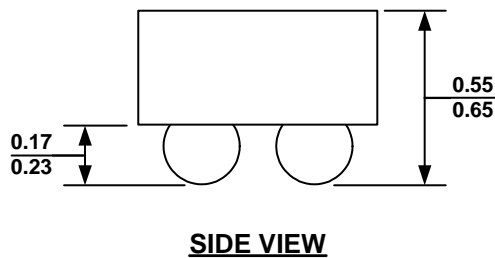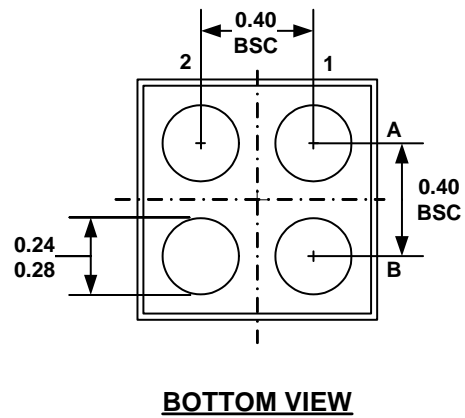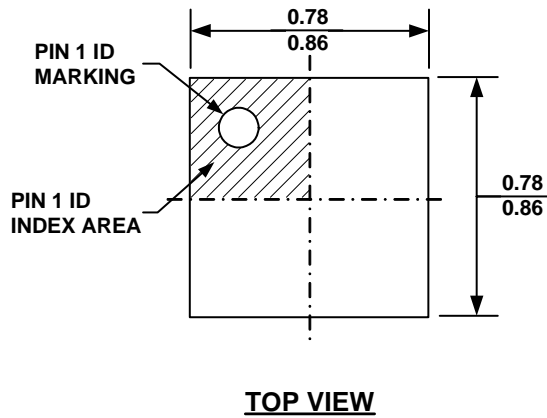
Output Capacitor Selection

The MP20049 is designed specifically to work with very low ESR ceramic output capacitor in space-limiting and performance consideration. Output capacitor of larger values will help to improve load transient response and reduce noise with the drawback of increased size. For the application circuit, the MP20049 requires a minimum capacitance of 0.7µF with an ESR of 1Ω or less.

Output Noise and PSRR

For MP20049, an internal 50pF bypass capacitor with new innovative structure reduces output noises greatly, without the need for an external bypass capacitor. The power supply rejection is 75dB at 10kHz and 55dB at 100kHz.

PACKAGE INFORMATION

WLCSP

PIN 1 ID MARKING

PIN 1 ID INDEX AREA

0.78
0.86

0.78
0.86

TOP VIEW

0.40
BSC

2   1

A

0.40
BSC

0.24
0.28

B

BOTTOM VIEW

0.55
0.65

0.17
0.23

SIDE VIEW

NOTE:

1) ALL DIMENSIONS ARE IN MILLIMETERS.
2) BALL COPLANARITY SHALL BE 0.05 MILLIMETER MAX.
3) JEDEC REFERENCE IS MO-211, VARIATION AA.
4) DRAWING IS NOT TO SCALE.

0.40

0.40

0.20

RECOMMENDED LAND PATTERN